

MOS FIELD EFFECT TRANSISTOR

2SK3204

SWITCHING

N-CHANNEL POWER MOS FET

INDUSTRIAL USE

DESCRIPTION

The 2SK3204 is N-Channel MOS Field Effect Transistor designed for high current switching applications.

FEATURES

- Low on-state resistance :
 $R_{DS(on)1} = 34 \text{ m}\Omega \text{ MAX. (} V_{GS} = 10 \text{ V, } I_D = 8 \text{ A)}$
 $R_{DS(on)2} = 50 \text{ m}\Omega \text{ MAX. (} V_{GS} = 4 \text{ V, } I_D = 8 \text{ A)}$
- Low C_{iss} : $C_{iss} = 940 \text{ pF TYP.}$
- Built-in gate protection diode.

ORDERING INFORMATION

PART NUMBER	PACKAGE
2SK3204	MP-10

ABSOLUTE MAXIMUM RATINGS ($T_A = 25^\circ\text{C}$)

Drain to Source Voltage ($V_{GS} = 0 \text{ V}$)	V_{DSS}	60	V
Gate to Source Voltage ($V_{DS} = 0 \text{ V}$)	$V_{GSS(AC)}$	± 20	V
Gate to Source Voltage ($V_{DS} = 0 \text{ V}$)	$V_{GSS(DC)}$	+20, -10	V
Drain Current (DC) ($T_C = 25^\circ\text{C}$)	$I_{D(DC)}$	± 15	A
Drain Current (pulse) ^{Note1}	$I_{D(pulse)}$	± 45	A
Total Power Dissipation ($T_A = 25^\circ\text{C}$)	P_T	1.8	W
Channel Temperature	T_{ch}	150	$^\circ\text{C}$
Storage Temperature	T_{stg}	-55 to +150	$^\circ\text{C}$
Single Avalanche Current ^{Note2}	I_{AS}	15	A
Single Avalanche Energy ^{Note2}	E_{AS}	22.5	mJ

Notes 1. $PW \leq 10 \mu\text{s}$, Duty Cycle $\leq 1\%$

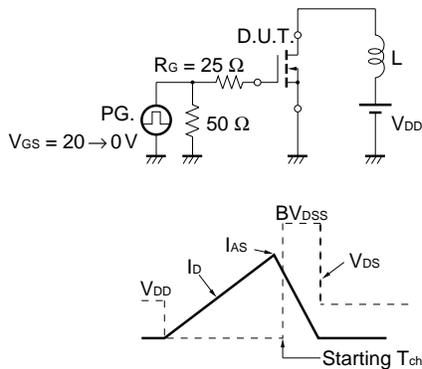
★ **2.** Starting $T_{ch} = 25^\circ\text{C}$, $V_{DD} = 30 \text{ V}$, $R_G = 25 \Omega$, $V_{GS} = 20 \rightarrow 0 \text{ V}$

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 Not all devices/types available in every country. Please check with local NEC representative for availability and additional information.

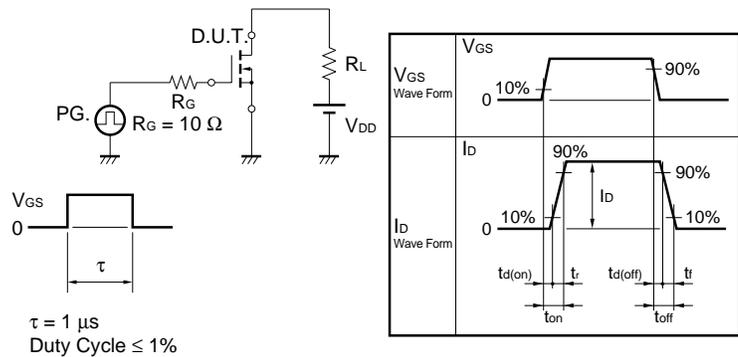
ELECTRICAL CHARACTERISTICS (T_A = 25°C)

PARAMETERS	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} = 60 V, V _{GS} = 0 V			10	μA
Gate Leakage Current	I _{GSS}	V _{GS} = ±20 V, V _{DS} = 0 V			±10	μA
Gate Cut-off Voltage	V _{GS(off)}	V _{DS} = 10 V, I _D = 1 mA	1.0	1.5	2.0	V
Forward Transfer Admittance	y _{fs}	V _{DS} = 10 V, I _D = 8 A	8.0	14		S
Drain to Source On-state Resistance	R _{DS(on)1}	V _{GS} = 10 V, I _D = 8 A		25	34	mΩ
	R _{DS(on)2}	V _{GS} = 4 V, I _D = 8 A		35	50	mΩ
Input Capacitance	C _{iss}	V _{DS} = 10 V		940		pF
Output Capacitance	C _{oss}	V _{GS} = 0 V		290		pF
Reverse Transfer Capacitance	C _{rss}	f = 1 MHz		120		pF
Turn-on Delay Time	t _{d(on)}	V _{DD} = 30 V, I _D = 8 A		17		ns
Rise Time	t _r	V _{GS} = 10 V		150		ns
Turn-off Delay Time	t _{d(off)}	R _G = 10 Ω		58		ns
Fall Time	t _f			52		ns
Total Gate Charge	Q _G	V _{DD} = 48 V		25		nC
Gate to Source Charge	Q _{GS}	V _{GS(on)} = 10 V		2.9		nC
Gate to Drain Charge	Q _{GD}	I _D = 15 A		7.5		nC
Body Diode Forward Voltage	V _{F(S-D)}	I _F = 15 A, V _{GS} = 0 V		0.92		V
Reverse Recovery Time	t _{rr}	I _F = 15 A, V _{GS} = 0 V		45		ns
Reverse Recovery Charge	Q _{rr}	di/dt = 100 A/μs		81		nC

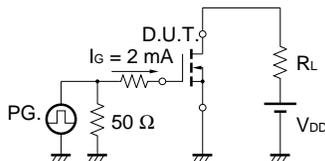
TEST CIRCUIT 1 AVALANCHE CAPABILITY



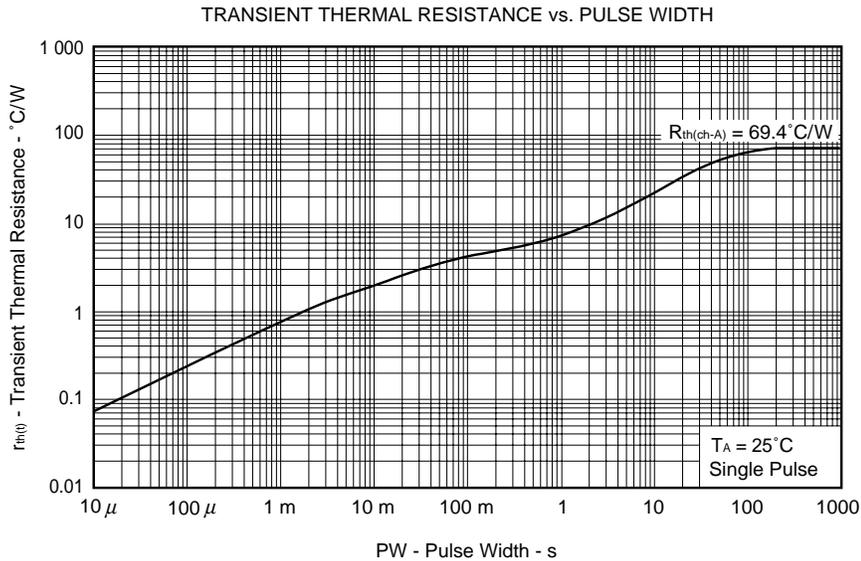
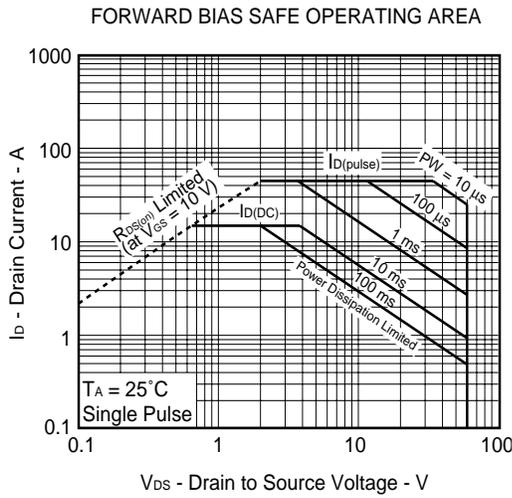
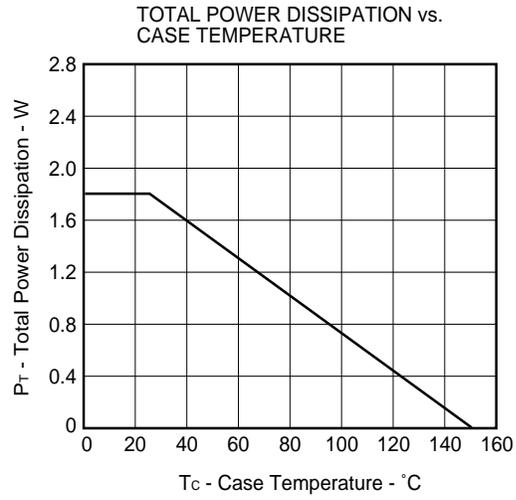
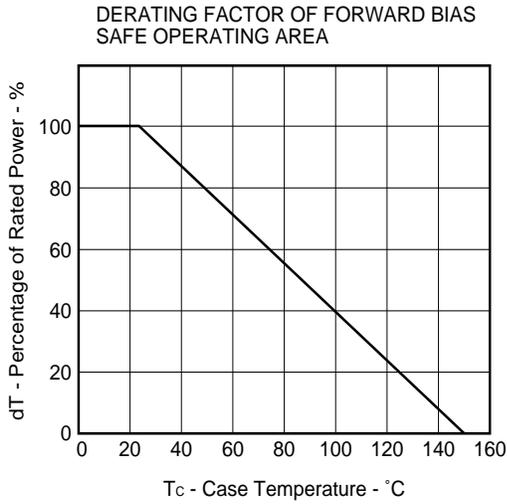
★ TEST CIRCUIT 2 SWITCHING TIME



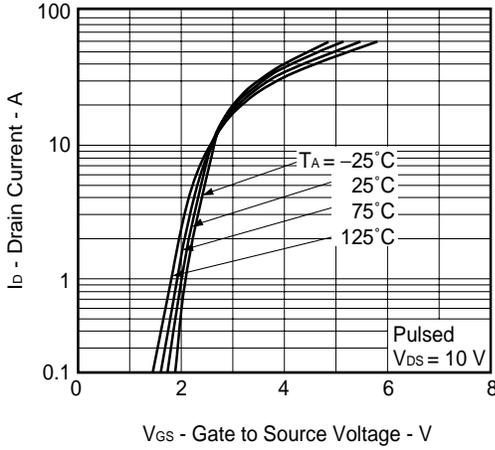
TEST CIRCUIT 3 GATE CHARGE



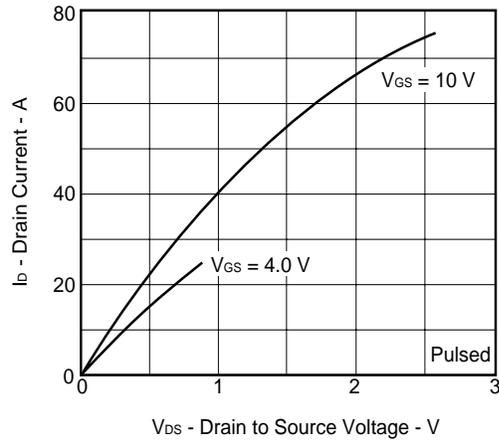
★ TYPICAL CHARACTERISTICS (T_A = 25°C)



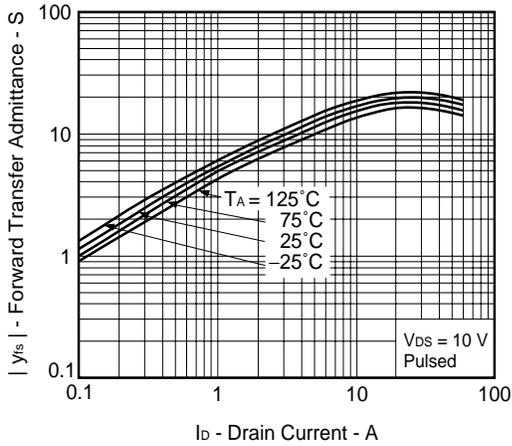
FORWARD TRANSFER CHARACTERISTICS



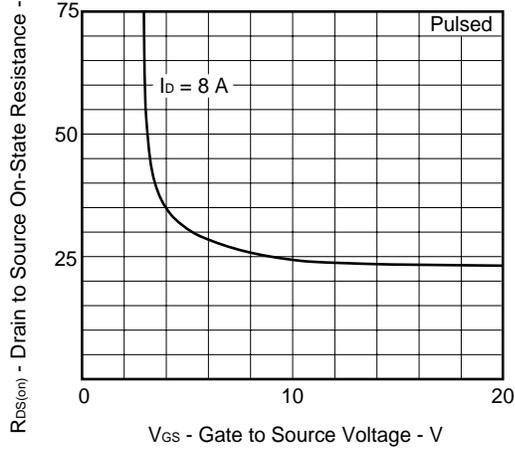
DRAIN CURRENT vs. DRAIN TO SOURCE VOLTAGE



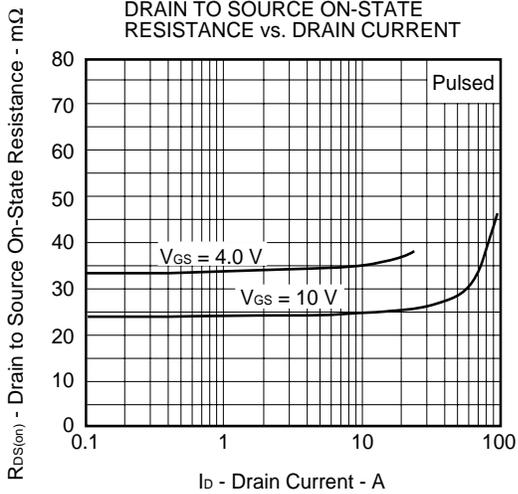
FORWARD TRANSFER ADMITTANCE vs. DRAIN CURRENT



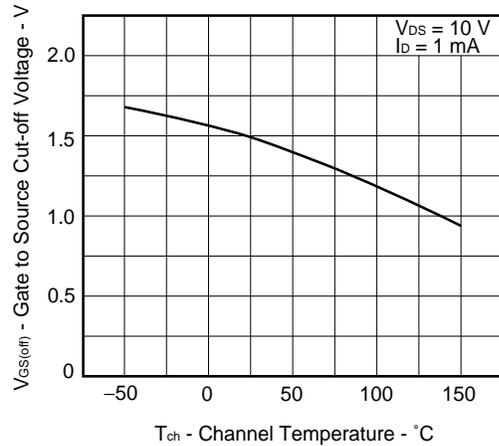
DRAIN TO SOURCE ON-STATE RESISTANCE vs. GATE TO SOURCE VOLTAGE

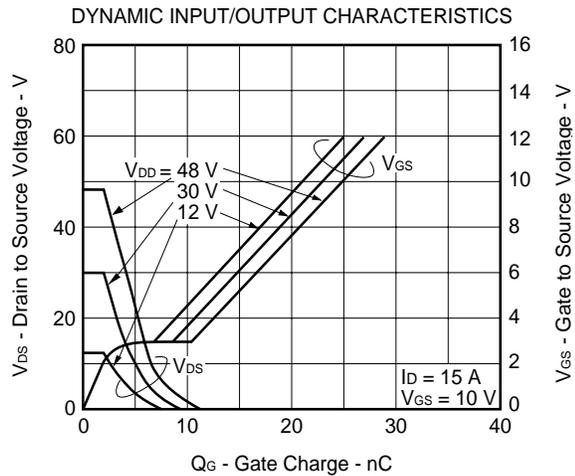
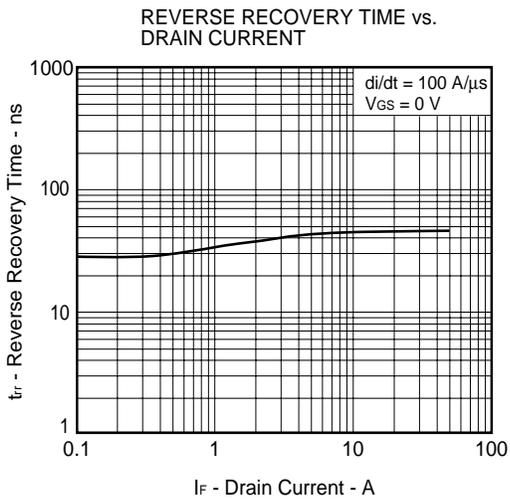
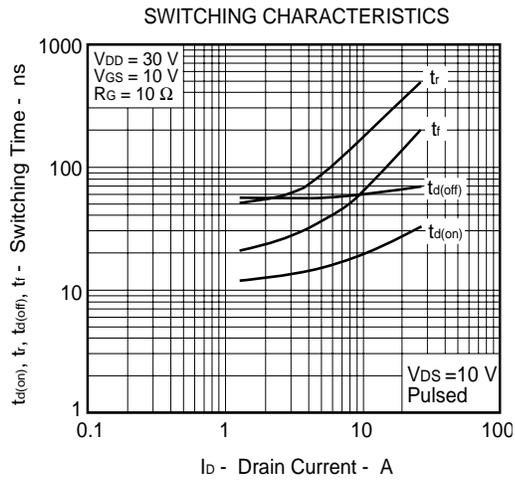
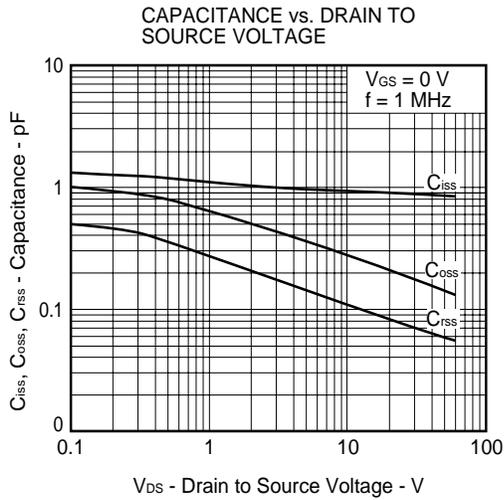
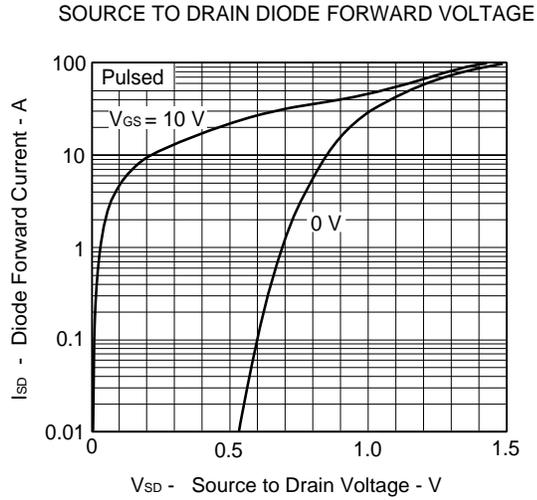
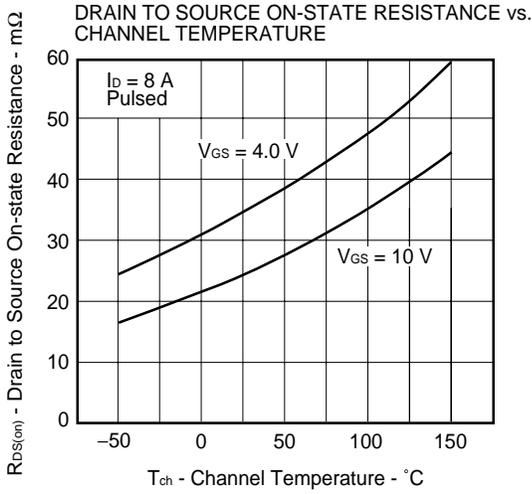


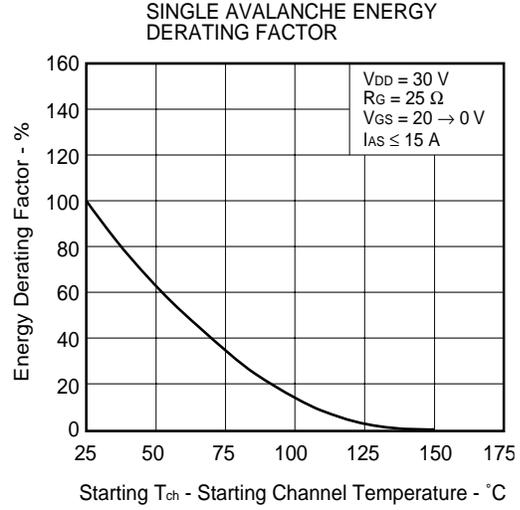
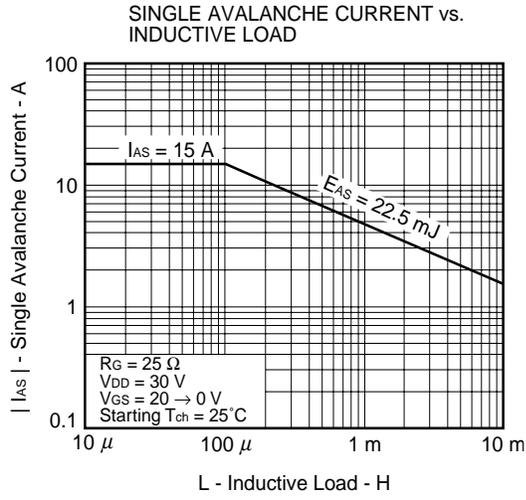
DRAIN TO SOURCE ON-STATE RESISTANCE vs. DRAIN CURRENT



GATE TO SOURCE CUT-OFF VOLTAGE vs. CHANNEL TEMPERATURE







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